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10/590683



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To the Director of the U.S. Patent and Trademark Office, send documents or the new address(es) below.

1. Names of conveying party(ies)/Execution Date(s):

- 1) SHIGEKI SATOU
- 2) TAKESHI NOMURA
- 3)
- 4)
- 5)
- 6)

Execution Dates:

- 1) JULY 25, 2006
- 2) JULY 25, 2006
- 3)
- 4)
- 5)
- 6)

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Joint Research Agreement
- ☐ Government Interest Assignment
- ☐ Executive Order 9424, Confirmatory License
- ☐ Other _____

2. Name and address of receiving party(ies):

Name: TDK CORPORATION

Internal Address: _____

Street Address: 1-13-1, NIHONBASHI, CHUO-KU

City: TOKYO

State: _____

Country: JAPAN Zip 103-8272

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

09/05/2006 LANDGRO 00000000 10590683

04 FC:3021

A. Patent Application No(s).

B. Patent No(s).

10/590683

(40.00 OP)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Seed Intellectual Property Law Group PLLC

Internal Address: DAVID V. CARLSON

Street Address: 701 Fifth Avenue, Suite 6300

City: Seattle

State: WA ZIP: 98104-7092

Phone Number: 206-622-4900

Fax Number: 206-682-6031

Email Address: davec@seedip.com

6. Total number of applications and patents involved

1

7. Total Fee (37 CFR 1.21(h) & 3.41): \$40

- ☐ Authorized to be charged by credit card.
- ☐ Authorized to be charged to deposit account.
- ☒ Enclosed
- ☐ None required (government interest not affecting title)

8. Payment Information

- a. Credit Card Last 4 Numbers _____
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- b. Deposit Account Number _____
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

DAVID V. CARLSON

Name of Person Signing

Signature

AUGUST 25, 2006

Date

Total number of pages including cover sheet, attachments, and document: 3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

Docket No. 890050.545USPC / 825720_1.DOC

ASSIGNMENT

WHEREAS, we, Shigeki Satou and Takeshi Nomura (hereinafter referred to as ASSIGNORS), having mailing addresses of c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan and c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, respectively, are the joint inventors of an invention entitled "CONDUCTIVE PASTE FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT AND A METHOD FOR MANUFACTURING A MULTI-LAYERED UNIT FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT," as described and claimed in the specification forming part of an application for United States letters patent executed herewith. This application claims the benefit of PCT International Application No. PCT/JP2005/002882, filed on February 23, 2005.

WHEREAS, TDK Corporation (hereinafter referred to as ASSIGNEE), a corporation of the Country of Japan having a place of business at 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

Shigeki Satou

I certify that I know or have satisfactory evidence that Shigeki Satou is the person who appeared before me, and said person acknowledged that he/she signed this instrument and acknowledged it to be his/her free and voluntary act for the uses and purposes mentioned in the instrument.

Date _____

Witness.

July 25, 2006

Date _____

Takeshi Nomura

Takeshi Nomura

I certify that I know or have satisfactory evidence that Takeshi Nomura is the person who appeared before me, and said person acknowledged that he/she signed this instrument and acknowledged it to be his/her free and voluntary act for the uses and purposes mentioned in the instrument.

Date _____

Witness.